

DB101S THRU DB107S

SINGLE-PHASE GLASS PASSIVATED SILICON BRIDGE RECTIFIER VOLTAGE RANGE 50 to 1000 Volts CURRENT 1.0 Ampere

FEATURES

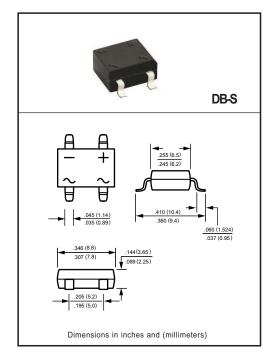
- * Good for automation insertion
- * Surge overload rating 30 amperes peak
- * Ideal for printed circuit board
- * Reliable low cost construction utilizing molded
- * Glass passivated device
- * Polarity symbols molded on body
- * Mounting position: Any

MECHANICAL DATA

* Epoxy: Device has UL flammability classification 94V-O

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25 $^{\circ}\text{C}$ ambient temperature unless otherwise specified. resistive or inductive load.



MAXIMUM RATINGS (At T_A = 25°C unless otherwise noted)

MAJIMUM KATINGS (ALTA = 23 C unless otherwise noted)										
RATINGS	SYMBOL	DB101S	DB102S	DB103S	DB104S	DB105S	DB106S	DB107S	UNITS	
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	Volts	
Maximum RMS Bridge Input Voltage	V _{RMS}	35	70	140	280	420	560	700	Volts	
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	Volts	
Maximum Average Forward Output Current at T _A = 40°C	I _O				1.0			Amps		
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	I _{FSM}	30							Amps	
Typical Current Squarad Time	l ² t	3.73							A ² Sec	
Typical Thermal Resistance (Note 2)	R _θ JA	40							°C/W	
Typical Thermal Resistance (Note 2)	R ₀ JL	15							2711	
Operating and Storage Temperature Range	TJ,TSTG	-55 to + 150						٥C		

ELECTRICAL CHARACTERISTICS (At T_A = 25°C unless otherwise noted)

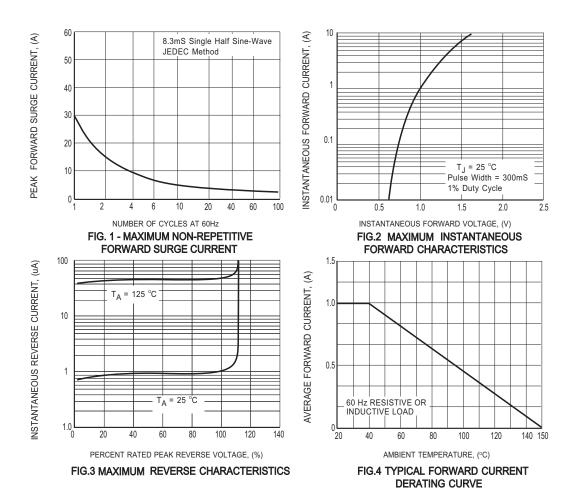
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CHARACTERISTICS	SYMBOL	DB101S	DB102S	DB103S	DB104S	DB105S	DB106S	DB107S	UNITS	
Maximum Forward Voltage Drop per chip (diod	V _F	1.0						Volts		
Maximum Reverse Current at Rated	@T _A = 25°C	ln.	1.0						uAmps	
DC Blocking Voltage per element	@T _A = 125°C	IR.	0.05							mAmps

Note: 1." ROHS compliant".

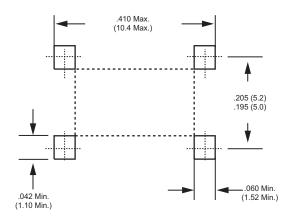
2. Thermal Resistance: Mounted on PCB.

2022-09/97

RATING AND CHARACTERISTICS CURVES (DB101S THRU DB107S)



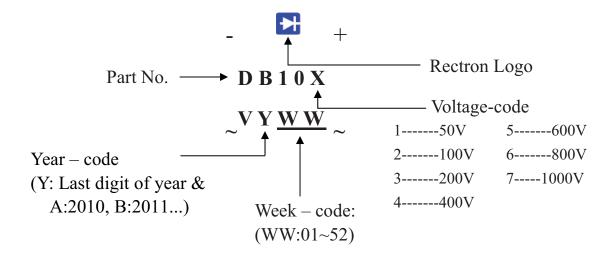
Mounting Pad Layout



Dimensions in inches and (millimeters)



Marking Description





PACKAGING OF DIODE AND BRIDGE RECTIFIERS

REEL PACK

PACKAGE	PACKING CODE	EA PER REEL	EA PER INNER BOX	COMPONENT SPACE (mm)	TAPE SPACE (mm)	REEL DIA (mm)	CARTON SIZE (mm)	EA PER CARTON	GROSS WEIGHT(Kg)
DB-S	-T/W	1,000	1,000	9.5	52	330	360*355*360	8,000	9.8



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